NX3DV642

3-lane high-speed MIPI compatible switch

Rev. 1 — 20 August 2012

Product data sheet

1. General description

The NX3DV642 is a high-speed triple-pole double-throw differential signal switch. The device is optimized for switching between two MIPI devices, such as cameras or LCD displays and on-board multimedia application processors.

The NX3DV642 is compatible with the requirements of Mobile Industry Processor Interface (MIPI). The low capacitance design allows the NX3DV642 to switch signals that exceed 500 MHz in frequency

2. Features and benefits

- Supply voltage range from 2.65 V to 4.3 V
- 7.5 Ω typical ON resistance
- 8.4 pF typical ON capacitance
- 950 MHz typical bandwidth or data frequency
- Low crosstalk of –55 dB at 100 MHz
- Break-before-make switching
- ESD protection:
 - ♦ HBM JESD22-A114F Class 2 exceeds 2000 V
 - CDM AEC-Q100-011 revision B exceeds 1000 V
 - ◆ HBM exceeds 12000 V for power to GND protection
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level A
- Specified from –40 °C to +85 °C

3. Applications

- Dual camera applications for cell phones
- Dual LCD applications for cell phones, digital camera displays and viewfinders

4. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
NX3DV642GU	–40 °C to +85 °C	XQFN24	plastic, extremely thin quad flat package; no leads; 24 terminals; body 2.5 x 3.4 x 0.5 mm	SOT1310-1



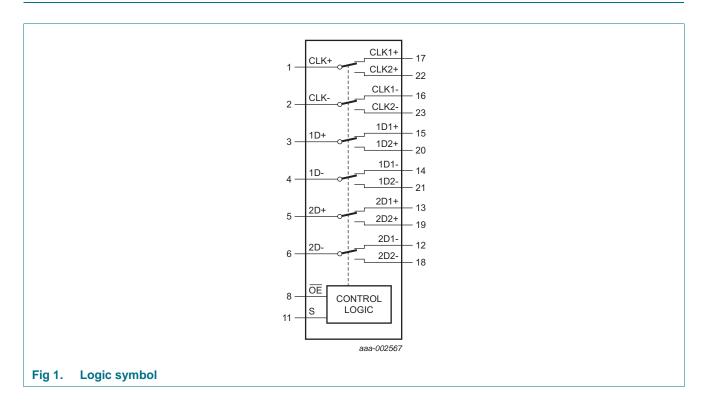
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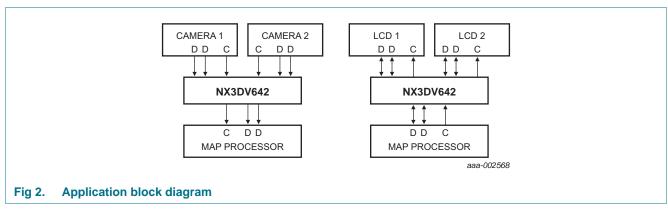
5. Marking

Table 2. Marking

Type number	Marking code
NX3DV642GU	3DV642

6. Functional diagram

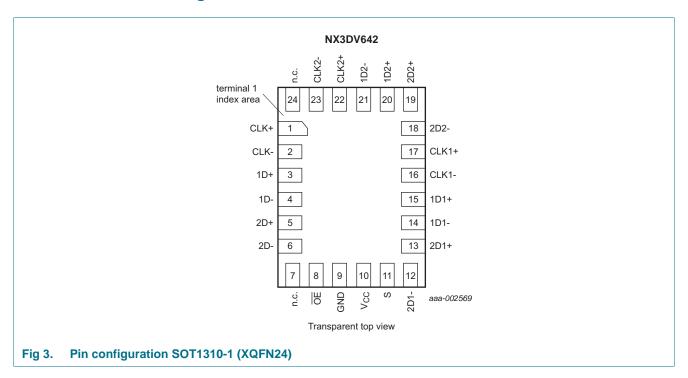




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7. Pinning information

7.1 Pinning



7.2 Pin description

Table 3. Pin description

Symbol	Pin	Description
CLK+, CLK-	1, 2	common output or input clock path
1D+, 1D-	3, 4	common output or input data path 1D
2D+, 2D-	5, 6	common output or input data path 2D
n.c.	7, 24	not connected
ŌĒ	8	output enable input (active LOW)
GND	9	ground (0 V)
V _{CC}	10	supply voltage
S	11	select input
2D1+, 2D1-	13, 12	independent input or output data path 2D1
1D1+, 1D1-	15, 14	independent input or output data path 1D1
CLK1+, CLK1-	17, 16	independent input or output clock path CLK1
2D2+, 2D2-	19, 18	independent input or output data path 2D2
1D2+, 1D2-	20, 21	independent input or output data path 1D2
CLK2+, CLK2-	22, 23	independent input or output clock path CLK2

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8. Functional description

Table 4. Function table[1]

Input		Channel on
S	OE	
L	L	CLKn, 1Dn, 2Dn = CLK1n, 1D1n, 2D1n
Н	L	CLKn, 1Dn, 2Dn = CLK2n, 1D2n, 2D2n
X	Н	switch off

^[1] H = HIGH voltage level; L = LOW voltage level; X = don't care. (n = + or -)

9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+5.5	V
V _I	input voltage	pins S and OE	<u>[1]</u> –0.5	+5.5	V
V_{SW}	switch voltage		-0.5	+5.5	V
I _{IK}	input clamping current	$V_1 < -0.5 \text{ V}$	-50	-	mA
I _{SK}	switch clamping current	$V_1 < -0.5 \text{ V}$	-50	+50	mA
I _{SW}	switch current		-100	+100	mA
I _{CC}	supply current		-	+50	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$	-	533	mW

^[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

10. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		2.65	4.3	V
VI	input voltage	pins S and OE	0	4.3	V
V_{SW}	switch voltage		<u>[1]</u> 0	4.5	V
T _{amb}	ambient temperature		-40	+85	°C

^[1] To avoid sinking GND current from terminals CLKn, 1Dn and 2Dn when switch current flows in terminals CLK1n, CLK2n, 1D1n 1D2n, 2D1n and 2D2n (n = + or -), the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminals CLKn, 1Dn and 2Dn, no GND current flows from terminals CLK1n, CLK2n, 1D1n 1D2n, 2D1n and 2D2n. In this case, there is no limit for the voltage drop across the switch.

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11. Static characteristics

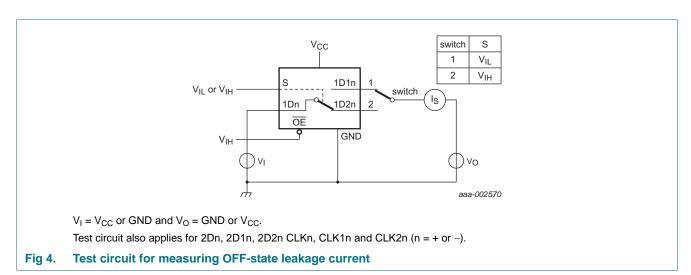
Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

Symbol	Parameter	Conditions		$T_{amb} = -40$ °C to +85 °C			
				Min	Typ[1]	Max	
V _{IH}	HIGH-level input	V _{CC} = 2.65 V to 2.775 V	'	1.3	-	-	V
	voltage	V _{CC} = 4.3 V		1.7	-	-	V
V_{IL}	LOW-level input	V _{CC} = 2.65 V to 2.775 V		-	-	0.5	V
	voltage	V _{CC} = 4.3 V		-	-	0.7	V
V_{IK}	input clamping voltage	$V_{CC} = 2.775 \text{ V}; I_I = -18 \text{ mA}$		-1.2	-	-	V
l _l	input leakage current	pins S and \overline{OE} ; V _I = GND to 4.3 V; V _{CC} = 4.3 V		-	-	±1	μΑ
I _{S(OFF)}	OFF-state leakage current	V _{CC} = 4.3 V; see <u>Figure 4</u>		-	-	±2	μΑ
I _{OFF}	power-off leakage current	V_1 or $V_O = 0$ V to 4.3 V; $V_{CC} = 0$ V		-	-	±2	μΑ
I _{cc}	supply current	$V_I = V_{CC}$ or GND; $V_{SW} = GND$ or V_{CC} ; $V_{CC} = 4.3 \text{ V}$		-	-	2	μΑ
Δl _{CC}	additional supply current	V_I = 1.8 V; V_{SW} = GND or V_{CC} ; V_{CC} = 2.775 V		-	-	1.5	μΑ
<u> </u>	innut consoitones	ning C and OF			1.2		
Cı	input capacitance	pins S and OE		-	1.3	-	pF
C _{S(OFF)}	OFF-state capacitance	pins CLK1n, CLK2n, 1D1n 1D2n, 2D1n and 2D2n; V _I = 0 V to 3.3 V	[2]	-	3.0	-	рF
C _{S(ON)}	ON-state capacitance	pins CLKn, 1Dn and 2Dn; V _I = 0 V to 3.3 V	[2]	-	8.4	-	pF

^[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 2.775 V.

11.1 Test circuits



NX3DV642

^[2] n = + or -.

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11.2 ON resistance

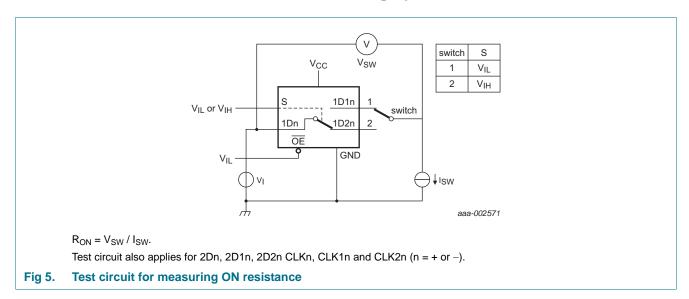
Table 8. ON resistance

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		-40 °C to +85 °C			
				Min	Typ[1]	Max	
low speed	mode	'	1			1	
R _{ON}	ON resistance	$V_I = 1.2 \text{ V}; I_{SW} = 10 \text{ mA}; \text{ see } \frac{\text{Figure 5}}{\text{M}}$					
		V _{CC} = 2.65 V		-	7.5	14	Ω
mi	ON resistance mismatch between channels	$V_{I} = 1.2 \text{ V}; I_{SW} = 10 \text{ mA}$	[2]				
		V _{CC} = 2.65 V		-	0.65	-	Ω
High spee	d mode						
R _{ON}	ON resistance	$V_I = 0.1 \text{ V}; I_{SW} = 10 \text{ mA}; \text{ see } \frac{\text{Figure 5}}{}$					
		V _{CC} = 2.65 V		-	5.5	9.5	Ω
ΔR_{ON}	ON resistance	$V_{I} = 0.1 \text{ V}; I_{SW} = 10 \text{ mA}$	[2]				
	mismatch between channels	V _{CC} = 2.65 V		-	0.65	-	Ω

^[1] Typical values are measured at T_{amb} = 25 °C.

11.3 ON resistance test circuit and graphs



^[2] Measured at identical V_{CC}, temperature and input voltage.

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12. Dynamic characteristics

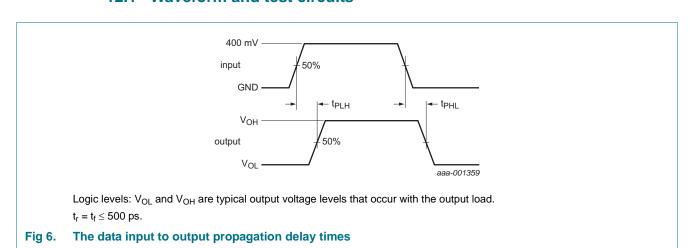
Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 9.

Symbol	Parameter	Conditions		$T_{amb} = -40$ °C to +85 °C			Unit
				Min	Typ[1]	Max	
t _{pd}	propagation delay	CLKn to CLK1n or CLK2n; 1Dn to 1D1n or 1D2n or 2Dn to 2D1n or 2D2n; see Figure 6	[2][3][4]				
		V _{CC} = 2.775 V		-	0.25	-	ns
t _{en} enable time	enable time	S or OE to CLKn, 1Dn or 2Dn; see Figure 7	[2][3]				
		V _{CC} = 2.65 V to 2.775 V		-	13.5	37	ns
t _{dis}	disable time	S or OE to CLKn, 1Dn or 2Dn; see Figure 7	[2][3]				
		V _{CC} = 2.65 V to 2.775 V		-	5.5	27	ns
t _{b-m}	break-before-make time	see Figure 8	[4]				
		V _{CC} = 2.65 V to 2.775 V		3	7	-	ns
t _{sk(p)}	pulse skew time	V_{CC} = 2.65 V to 2.775 V; V_{SW} = 0.2 V (p-p)	[4]	-	10	-	ps
t _{sk(o)}	output skew time	V_{CC} = 2.65 V to 2.775 V; V_{SW} = 0.2 V (p-p)	[4]	-	15	-	ps
t _{sk(pr)}	process skew time	V_{CC} = 2.65 V to 2.775 V; V_{SW} = 0.2 V (p-p)	<u>[4]</u>	-	40	-	ps

^[1] Typical values are measured at T_{amb} = 25 °C, C_L = 5 pF and V_{CC} = 2.775 V.

12.1 Waveform and test circuits



^[2] n = + or -.

 $[\]begin{array}{ll} [3] & t_{pd} \text{ is the same as } t_{PLH} \text{ and } t_{PHL}. \\ & t_{en} \text{ is the same as } t_{PZH} \\ & t_{dis} \text{ is the same as } t_{PHZ} \end{array}$

^[4] Guaranteed by design.

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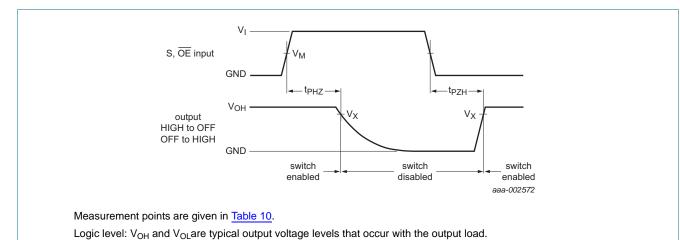
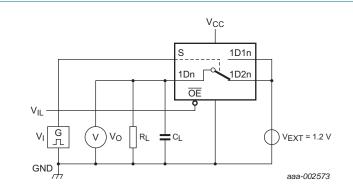


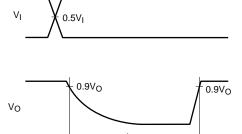
Fig 7. Enable and disable times

Table 10. Measurement points

Supply voltage	Input		Output	
V _{CC}	V_{M}	V _I	V _X	
2.65 V to 2.775 V	0.5V _{CC}	V _{CC}	0.9V _{OH}	



a. Test circuit.



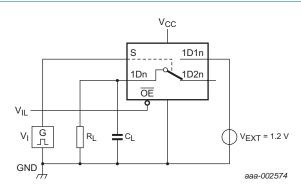
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b. Input and output measurement points

Test circuit also applies for 2Dn, 2D1n, 2D2n CLKn, CLK1n and CLK2n (n = + or -).

Fig 8. Test circuit for measuring break-before-make timing

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Test circuit also applies for 2Dn, 2D1n, 2D2n CLKn, CLK1n and CLK2n (n = + or −).

Test data is given in Table 11.

Definitions test circuit:

 R_T = Termination resistance (should be equal to output impedance Z_0 of the pulse generator).

R_L = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

V_{EXT} = External voltage for measuring switching times.

 V_I may be connected to S or \overline{OE} .

Fig 9. Test circuit for measuring switching times

Table 11. Test data

Supply voltage	Input		Load	
V _{CC}	V _I	t _r , t _f	C _L	R _L
2.65 V to 2.775 V	V_{CC}	\leq 2.5 ns	5 pF	50 Ω

12.2 Additional dynamic characteristics

Table 12. Additional dynamic characteristics

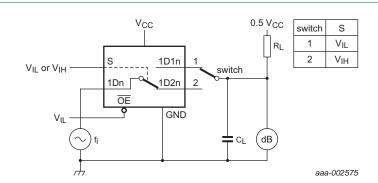
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); $V_l = \text{GND}$ or V_{CC} (unless otherwise specified); $t_r = t_f \le 2.5$ ns.

Symbol	Parameter Conditions			Ta	_{amb} = 25 °C		Unit
				Min	Тур	Max	
f _(-3dB) -3 dB frequency response	$R_L = 50 \Omega$; see <u>Figure 10</u>	<u>[1]</u>		•		'	
	$C_L = 0 \text{ pF}; V_{CC} = 2.775 \text{ V}$		-	950	-	MHz	
$\alpha_{\text{iso}} \qquad \text{isolation (OFF-state)}$	isolation (OFF-state)	f_i = 100 MHz; R_L = 50 Ω ; see Figure 11	<u>[1]</u>				
		V _{CC} = 2.775 V		-	-35	-	dB
Xtalk cros	crosstalk	between switches; $f_i = 100 \text{ MHz}$; $R_L = 50 \Omega$; see Figure 12	<u>[1]</u>				
		V _{CC} = 2.775 V		-	-55	-	dB

[1] f_i is biased at 0.5 V_{CC} .

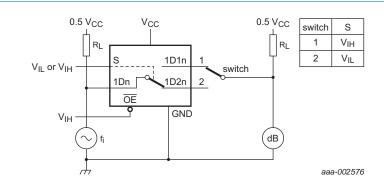
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12.3 Test circuits



Adjust f_i voltage to obtain 0 dBm level at output. Increase f_i frequency until dB meter reads -3 dB. Test circuit also applies for 2Dn, 2D1n, 2D2n CLKn, CLK1n and CLK2n (n = + or -).

Fig 10. Test circuit for measuring the frequency response when channel is in ON-state

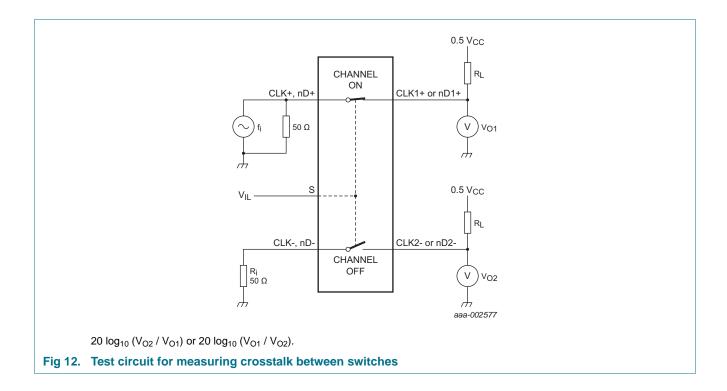


Adjust fi voltage to obtain 0 dBm level at input.

Test circuit also applies for 2Dn, 2D1n, 2D2n CLKn, CLK1n and CLK2n (n = + or -).

Fig 11. Test circuit for measuring isolation (OFF-state)

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13. Package outline

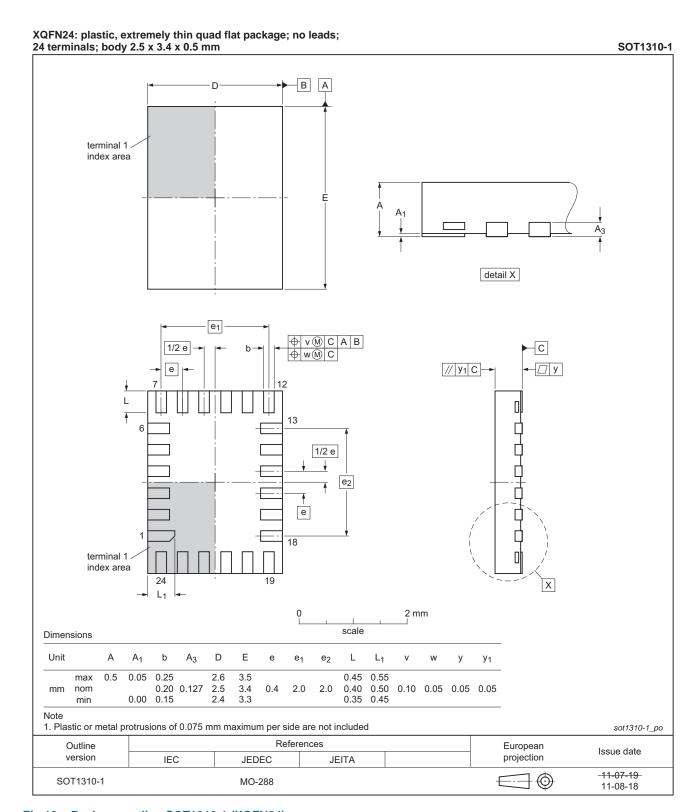


Fig 13. Package outline SOT1310-1 (XQFN24)

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14. Abbreviations

Table 13. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

15. Revision history

Table 14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NX3DV642 v.1	20120820	Product data sheet	-	-

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16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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